CMOS Digital Integrated Circuits Silicon Monolithic

74HC273D

1. Functional Description

· Octal D-Type Flip-Flop with Clear

2. General

The 74HC273D is a high speed CMOS OCTAL D-TYPE FLIP FLOP fabricated with silicon gate C2MOS technology.

It achieves the high speed operation similar to equivalent LSTTL while maintaining the CMOS low power dissipation.

Information signals applied to D inputs are transferred to the Q outputs on the positive going edge of the clock pulse.

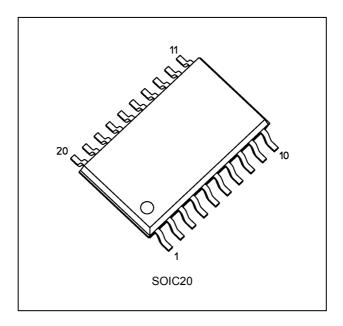
When the $\overline{\text{CLR}}$ input is held "L", the Q outputs are at a low logic level independent of the other inputs.

All inputs are equipped with protection circuits against static discharge or transient excess voltage.

3. Features

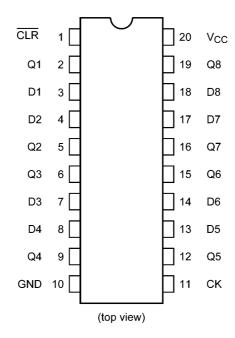
- (1) High speed: $f_{MAX} = 67 \text{ MHz}$ (typ.) at $V_{CC} = 5 \text{ V}$
- (2) Low power dissipation: $I_{CC} = 4.0 \mu A \text{ (max)}$ at $T_a = 25^{\circ}\text{C}$
- (3) Balanced propagation delays: $t_{PLH} \approx t_{PHL}$
- (4) Wide operating voltage range: $V_{CC(opr)} = 2.0 \text{ V}$ to 6.0 V

4. Packaging

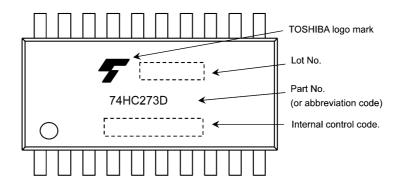




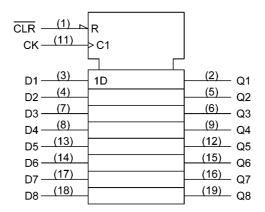
5. Pin Assignment



6. Marking



7. IEC Logic Symbol



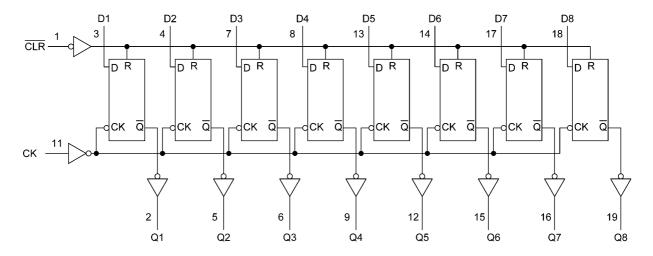


8. Truth Table

	Inputs		Output	Function
CLR	D	СК	Q	Function
L	Х	Х	L	Clear
Н	L		L	_
Н	Н	<u></u>	Н	
Н	Х		Qn	No Change

X: Don't care

9. System Diagram





10. Absolute Maximum Ratings (Note)

Characteristics	Symbol	Note	Rating	Unit
Supply voltage	V _{CC}		-0.5 to 7.0	V
Input voltage	V _{IN}		-0.5 to V _{CC} + 0.5	V
Output voltage	V _{OUT}		-0.5 to V _{CC} + 0.5	V
Input diode current	I _{IK}		±20	mA
Output diode current	I _{OK}		±20	mA
Output current	I _{OUT}		±25	mA
V _{CC} /ground current	I _{CC}		±50	mA
Power dissipation	P_{D}	(Note 1)	500	mW
Storage temperature	T _{stg}		-65 to 150	°C

Note: Exceeding any of the absolute maximum ratings, even briefly, lead to deterioration in IC performance or even destruction.

Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings and the operating ranges.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 1: PD derates linearly with -8 mW/°C above 85°C

11. Operating Ranges (Note)

Characteristics	Symbol	Test Condition	Rating	Unit
Supply voltage	V _{CC}	_	2.0 to 6.0	V
Input voltage	V _{IN}		0 to V _{CC}	V
Output voltage	V _{OUT}	_	0 to V _{CC}	V
Operating temperature	T _{opr}	_	-40 to 125	°C
Input rise and fall times	t _r ,t _f	_	0 to 50	μS

Note: The operating ranges must be maintained to ensure the normal operation of the device. Unused inputs and bus inputs must be tied to either V_{CC} or GND.



12. Electrical Characteristics

12.1. DC Characteristics (Unless otherwise specified, T_a = 25 °C)

Characteristics	Symbol	Test Condition		V _{CC} (V)	Min	Тур.	Max	Unit
High-level input voltage	V _{IH}	_		2.0	1.50	_	_	V
				4.5	3.15	_	_	
				6.0	4.20	_		
Low-level input voltage	V _{IL}	_		2.0			0.50	٧
				4.5			1.35	
				6.0			1.80	
High-level output voltage	V _{OH}	$V_{IN} = V_{IH}$ or V_{IL}	I _{OH} = -20 μA	2.0	1.9	2.0	_	V
				4.5	4.4	4.5		
				6.0	5.9	6.0	_	
			I _{OH} = -4 mA	4.5	4.18	4.31	_	
			$I_{OH} = -5.2 \text{ mA}$	6.0	5.68	5.80		
Low-level output voltage	V _{OL}	$V_{IN} = V_{IH}$ or V_{IL}	I _{OL} = 20 μA	2.0	_	0.0	0.1	V
				4.5	_	0.0	0.1	
				6.0	_	0.0	0.1	
			I _{OL} = 4 mA	4.5	_	0.17	0.26	
			I _{OL} = 5.2 mA	6.0		0.18	0.26	
Input leakage current	I _{IN}	$V_{IN} = V_{CC}$ or GND		6.0			±0.1	μА
Quiescent supply current	I _{CC}	$V_{IN} = V_{CC}$ or GND		6.0	_	_	4.0	μΑ

12.2. DC Characteristics (Unless otherwise specified, T_a = -40 to 85 °C)

Characteristics	Symbol	Test Condition		V _{CC} (V)	Min	Max	Unit
High-level input voltage	V _{IH}	_		2.0	1.50	_	V
				4.5	3.15	_	
				6.0	4.20	_	
Low-level input voltage	V _{IL}	_		2.0	_	0.50	V
				4.5	_	1.35	
				6.0	_	1.80	
High-level output voltage	V _{OH}	V _{IN} = V _{IH} or V _{IL}	I _{OH} = -20 μA	2.0	1.9	_	V
				4.5	4.4	_	
				6.0	5.9	_	
			I _{OH} = -4 mA	4.5	4.13	_	
			I _{OH} = -5.2 mA	6.0	5.63	_	
Low-level output voltage	V _{OL}	V _{IN} = V _{IH} or V _{IL}	I _{OL} = 20 μA	2.0	_	0.1	V
				4.5	_	0.1	
				6.0	_	0.1	
			I _{OL} = 4 mA	4.5	_	0.33	
			I _{OL} = 5.2 mA	6.0	_	0.33	
Input leakage current	I _{IN}	V _{IN} = V _{CC} or GND		6.0	_	±1.0	μА
Quiescent supply current	I _{CC}	V _{IN} = V _{CC} or GND		6.0	_	40.0	μА



12.3. DC Characteristics (Unless otherwise specified, T_a = -40 to 125 °C)

Characteristics	Symbol	Test Condition		V _{CC} (V)	Min	Max	Unit
High-level input voltage	V _{IH}	_	_		1.50	_	V
				4.5	3.15	_	
				6.0	4.20	_	1 I
Low-level input voltage	V _{IL}	_		2.0	_	0.50	V
				4.5	_	1.35	
				6.0	_	1.80]
High-level output voltage	V _{OH}	V _{IN} = V _{IH} or V _{IL}	I _{OH} = -20 μA	2.0	1.9	_	V
				4.5	4.4	_	
				6.0	5.9	_]
			I _{OH} = -4 mA	4.5	3.7	_]
			I _{OH} = -5.2 mA	6.0	5.2	_	
Low-level output voltage	V _{OL}	V _{IN} = V _{IH} or V _{IL}	I _{OL} = 20 μA	2.0	_	0.1	V
				4.5	_	0.1	
				6.0	_	0.1	
			I _{OL} = 4 mA	4.5	_	0.4]
			I _{OL} = 5.2 mA	6.0	_	0.4	
Input leakage current	I _{IN}	V _{IN} = V _{CC} or GND		6.0	_	±1.0	μА
Quiescent supply current	I _{CC}	$V_{IN} = V_{CC}$ or GND		6.0	_	160.0	μА



12.4. Timing Requirements (Unless otherwise specified, $T_a = 25^{\circ}C$, Input: $t_f = t_f = 6$ ns)

Characteristics	Symbol	Test Condition	V _{CC} (V)	Limit	Unit
Minimum pulse width	$t_{w(L)}, t_{w(H)}$	_	2.0	75	ns
(CK)			4.5	15	
			6.0	13	1
Minimum pulse width	t _{w(L)}	_	2.0	75	ns
LR)			4.5	15	
			6.0	13	1
Minimum setup time	t _S	_	2.0	75	ns
			4.5	15	
			6.0	13	1
Minimum hold time	t _h	_	2.0	0	ns
			4.5	0	
			6.0	0	1
Minimum removal time	t _{rem}	_	2.0	50	ns
(CLR)			4.5	10	
			6.0	9	1
Clock frequency	f	_	2.0	6	MHz
			4.5	30	
			6.0	35	

12.5. Timing Requirements (Unless otherwise specified, T_a = -40 to 85°C, Input: t_f = t_f = 6 ns)

Characteristics	Symbol	Test Condition	V _{CC} (V)	Limit	Unit
Minimum pulse width	$t_{w(L)}, t_{w(H)}$	_	2.0	95	ns
(CK)			4.5	19	
			6.0	16	
Minimum pulse width	t _{w(L)}		2.0	95	ns
(CLR)			4.5	19	
			6.0	16	
Minimum setup time	t _S	_	2.0	95	ns
			4.5	19	
			6.0	16	
Minimum hold time	t _h	_	2.0	0	ns
			4.5	0	
			6.0	0	
Minimum removal time	t _{rem}	_	2.0	65	ns
(CLR)			4.5	13	
			6.0	11	
Clock frequency	f	_	2.0	5	MHz
			4.5	24	
			6.0	28	



12.6. Timing Requirements (Unless otherwise specified, T_a = -40 to 125 °C, Input: t_f = t_f = 6 ns)

Characteristics	Symbol	Test Condition	V _{CC} (V)	Limit	Unit
Minimum pulse width	$t_{w(L)}, t_{w(H)}$	_	2.0	120	ns
(CK)			4.5	24	
			6.0	20	
Minimum pulse width	t _{w(L)}	_	2.0	120	ns
(CLR)			4.5	24	
			6.0	20	
Minimum setup time	t _S	_	2.0	120	ns
			4.5	24	
			6.0	20	
Minimum hold time	t _h	_	2.0	0	ns
			4.5	0	1
			6.0	0	
Minimum removal time	t _{rem}	_	2.0	75	ns
(CLR)			4.5	15	
			6.0	13	
Clock frequency	f	_	2.0	4	MHz
			4.5	20	1
			6.0	24	1

12.7. AC Characteristics (Unless otherwise specified, C_L = 15 pF, V_{CC} = 5 V, T_a = 25 °C, Input: t_r = t_f = 6 ns)

Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Output transition time	t_{TLH}, t_{THL}	_	_	4	8	ns
Propagation delay time (CK-Q)	t _{PLH} ,t _{PHL}	_	_	15	25	ns
Propagation delay time (CLR-Q)	t _{PHL}	_	_	16	27	ns
Maximum clock frequency	f _{MAX}	_	40	67	_	MHz



12.8. AC Characteristics (Unless otherwise specified, C_L = 50 pF, T_a = 25 °C, Input: t_r = t_f = 6 ns)

Characteristics	Symbol	Note	Test Condition	V _{CC} (V)	Min	Тур.	Max	Unit
Output transition time	t _{TLH} ,t _{THL}		_	2.0	_	25	75	ns
				4.5	_	7	15	
				6.0	_	6	13	
Propagation delay time	t _{PLH} ,t _{PHL}		_	2.0	_	54	145	ns
(CK-Q)				4.5	_	18	29	
				6.0	_	15	25	
Propagation delay time	t _{PHL}		_	2.0	_	60	160	ns
(CLR-Q)				4.5	_	20	32	
				6.0	_	17	27	
Maximum clock frequency	f _{MAX}		_	2.0	6	18	_	MHz
				4.5	30	56	_	
				6.0	36	66	_	
Input capacitance	C _{IN}		_	_	_	3	_	pF
Power dissipation capacitance	C _{PD}	(Note 1)	_	_		11		pF

Note 1: C_{PD} is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption without load. Average operating current can be obtained by the equation. $I_{CC(opr)} = C_{PD} \times V_{CC} \times f_{|N} + I_{CC}/8 \text{ (per bit)}$

12.9. AC Characteristics (Unless otherwise specified, $C_L = 50$ pF, $T_a = -40$ to 85 °C, Input: $t_r = t_f = 6$ ns)

Characteristics	Symbol	Test Condition	V _{CC} (V)	Min	Max	Unit
Output transition time	t_{TLH}, t_{THL}	_	2.0	_	95	ns
			4.5	_	19	
			6.0	_	16]
Propagation delay time	t _{PLH} ,t _{PHL}	_	2.0	_	180	ns
(CK-Q)			4.5	_	36	
			6.0	_	31]
Propagation delay time	t _{PHL}	_	2.0	_	200	ns
(CLR-Q)			4.5	_	40	
			6.0	_	34	
Maximum clock frequency	f _{MAX}	_	2.0	5	_	MHz
			4.5	24	_]
			6.0	28	_	



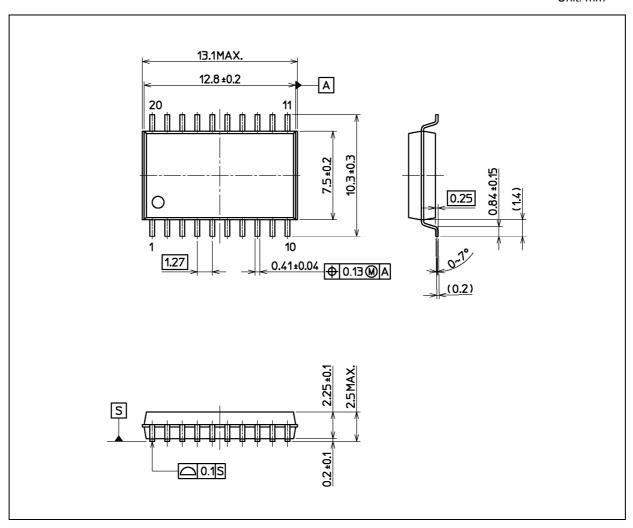
12.10. AC Characteristics (Unless otherwise specified, C_L = 50 pF, T_a = -40 to 125 °C, Input: t_f = t_f = 6 ns)

Characteristics	Symbol	Test Condition	V _{CC} (V)	Min	Max	Unit
Output transition time	t _{TLH} ,t _{THL}	_	2.0	_	110	ns
			4.5	_	22	
			6.0	_	19	
Propagation delay time (CK-Q)	t _{PLH} ,t _{PHL}	ı	2.0	_	225	ns
			4.5	_	45	
			6.0	_	38	
Propagation delay time (CLR-Q)	t _{PHL}	_	2.0	_	225	ns
			4.5	_	45	
			6.0	_	38	
Maximum clock frequency	f _{MAX}	_	2.0	4	_	MHz
			4.5	20	_	
			6.0	24	_	



Package Dimensions

Unit: mm



Weight: 0.51 g (typ.)

	Package Name(s)
Nickname: SOIC20	



RESTRICTIONS ON PRODUCT USE

- Toshiba Corporation, and its subsidiaries and affiliates (collectively "TOSHIBA"), reserve the right to make changes to the information in this document, and related hardware, software and systems (collectively "Product") without notice.
- This document and any information herein may not be reproduced without prior written permission from TOSHIBA. Even with TOSHIBA's
 written permission, reproduction is permissible only if reproduction is without alteration/omission.
- Though TOSHIBA works continually to improve Product's quality and reliability, Product can malfunction or fail. Customers are responsible for complying with safety standards and for providing adequate designs and safeguards for their hardware, software and systems which minimize risk and avoid situations in which a malfunction or failure of Product could cause loss of human life, bodily injury or damage to property, including data loss or corruption. Before customers use the Product, create designs including the Product, or incorporate the Product into their own applications, customers must also refer to and comply with (a) the latest versions of all relevant TOSHIBA information, including without limitation, this document, the specifications, the data sheets and application notes for Product and the precautions and conditions set forth in the "TOSHIBA Semiconductor Reliability Handbook" and (b) the instructions for the application with which the Product will be used with or for. Customers are solely responsible for all aspects of their own product design or applications, including but not limited to (a) determining the appropriateness of the use of this Product in such design or applications; (b) evaluating and determining the applicability of any information contained in this document, or in charts, diagrams, programs, algorithms, sample application circuits, or any other referenced documents; and (c) validating all operating parameters for such designs and applications.
 TOSHIBA ASSUMES NO LIABILITY FOR CUSTOMERS' PRODUCT DESIGN OR APPLICATIONS.
- PRODUCT IS NEITHER INTENDED NOR WARRANTED FOR USE IN EQUIPMENTS OR SYSTEMS THAT REQUIRE
 EXTRAORDINARILY HIGH LEVELS OF QUALITY AND/OR RELIABILITY, AND/OR A MALFUNCTION OR FAILURE OF WHICH MAY
 CAUSE LOSS OF HUMAN LIFE, BODILY INJURY, SERIOUS PROPERTY DAMAGE AND/OR SERIOUS PUBLIC IMPACT
 ("UNINTENDED USE"). Except for specific applications as expressly stated in this document, Unintended Use includes, without limitation,
 equipment used in nuclear facilities, equipment used in the aerospace industry, medical equipment, equipment used for automobiles,
 trains, ships and other transportation, traffic signaling equipment, equipment used to control combustions or explosions, safety devices,
 elevators and escalators, devices related to electric power, and equipment used in finance-related fields. IF YOU USE PRODUCT FOR
 UNINTENDED USE, TOSHIBA ASSUMES NO LIABILITY FOR PRODUCT. For details, please contact your TOSHIBA sales
 representative.
- · Do not disassemble, analyze, reverse-engineer, alter, modify, translate or copy Product, whether in whole or in part.
- Product shall not be used for or incorporated into any products or systems whose manufacture, use, or sale is prohibited under any
 applicable laws or regulations.
- The information contained herein is presented only as guidance for Product use. No responsibility is assumed by TOSHIBA for any
 infringement of patents or any other intellectual property rights of third parties that may result from the use of Product. No license to any
 intellectual property right is granted by this document, whether express or implied, by estoppel or otherwise.
- ABSENT A WRITTEN SIGNED AGREEMENT, EXCEPT AS PROVIDED IN THE RELEVANT TERMS AND CONDITIONS OF SALE
 FOR PRODUCT, AND TO THE MAXIMUM EXTENT ALLOWABLE BY LAW, TOSHIBA (1) ASSUMES NO LIABILITY WHATSOEVER,
 INCLUDING WITHOUT LIMITATION, INDIRECT, CONSEQUENTIAL, SPECIAL, OR INCIDENTAL DAMAGES OR LOSS, INCLUDING
 WITHOUT LIMITATION, LOSS OF PROFITS, LOSS OF OPPORTUNITIES, BUSINESS INTERRUPTION AND LOSS OF DATA, AND
 (2) DISCLAIMS ANY AND ALL EXPRESS OR IMPLIED WARRANTIES AND CONDITIONS RELATED TO SALE, USE OF PRODUCT,
 OR INFORMATION, INCLUDING WARRANTIES OR CONDITIONS OF MERCHANTABILITY, FITNESS FOR A PARTICULAR
 PURPOSE, ACCURACY OF INFORMATION, OR NONINFRINGEMENT.
- Do not use or otherwise make available Product or related software or technology for any military purposes, including without limitation, for the design, development, use, stockpiling or manufacturing of nuclear, chemical, or biological weapons or missile technology products (mass destruction weapons). Product and related software and technology may be controlled under the applicable export laws and regulations including, without limitation, the Japanese Foreign Exchange and Foreign Trade Law and the U.S. Export Administration Regulations. Export and re-export of Product or related software or technology are strictly prohibited except in compliance with all applicable export laws and regulations.
- Please contact your TOSHIBA sales representative for details as to environmental matters such as the RoHS compatibility of Product.
 Please use Product in compliance with all applicable laws and regulations that regulate the inclusion or use of controlled substances, including without limitation, the EU RoHS Directive. TOSHIBA ASSUMES NO LIABILITY FOR DAMAGES OR LOSSES OCCURRING AS A RESULT OF NONCOMPLIANCE WITH APPLICABLE LAWS AND REGULATIONS.

X-ON Electronics

Largest Supplier of Electrical and Electronic Components

Click to view similar products for Flip-Flops category:

Click to view products by Toshiba manufacturer:

Other Similar products are found below:

NLV14027BDG NLX1G74MUTCG 703557B 5962-90606022A 5962-9060602FA NLV14013BDR2G M38510/30104BDA M38510/07106BFA NTE4598B 74LVC74APW-Q100J 74LCX16374MTDX 74LVT74D,118 74VHCT9273FT(BJ) MM74HC374WM 74LVX74MTCX CD40174BF3A HMC723LC3CTR 5962-8681501RA MM74HCT273WM SN74LVC74APW SN74LVC74AD SN74HC273DWR MC74HC11ADG M74HC175B1R M74HC174RM13TR 74ALVTH16374ZQLR 74ALVTH32374ZKER 74VHC9273FT(BJ) 74VHCV374FT(BJ) 74VHCV574FT(BJ) SNJ54ALS574BJ SN74LVC74ADR SN74HC574PWR SN74HC374AN SN74AS574DWR SN74ALS175NSR SN74HC175D SN74AC74D 74AHC1G79GV.125 74AHC74D.112 74HC112D.652 74HC574D.652 74HCT173D.652 74HCT374D.652 74AHC574D.118 74AHCT1G79GW.125 74HC273D.652 74HC74D.653 74HC107D.652 74HC574D.653